

# RFPO45

**Specifications** 

**SPECIFICATION REFERENCES** 

1.0

210	OI ECTI TO TITOTI THE ETTE	11020		
Line	Parameter	Description		
1.1	Part number	M6326LF, iss. & (201(-%\$-\$%)		
1.2	Description	20.0MHz MERC 9x7 HOT CMOS 3.3V		
1.3	RoHS compliant	Yes		
1.4	Package size	9.7 mm x 7.5 mm x 4.3 mm		
2.0	FREQUENCY CHARACTER	RISTICS		
Line	Parameter	Test Condition	Value	Unit
2.1	Nominal frequency		20.0	MHz
2.2	Frequency calibration	At 25°C±2°C, at time of shipment, reference to nominal frequency (note 1)	±0.5 max	ppm
2.3	Reflow shift	After 1 hour recovery at 25°C	±1 max	ppm
2.4	Frequency stability over temperature in still air	Reference to (Fmax+Fmin)/2 (note 1)	±20 max	ppb
2.5	Temperature range	The operating temperature range over which the frequency stability is measured	0 to 85	°C
2.6	Frequency slope in still air	Temperature ramp 1°C/minute max.	±2 max	ppb/°C
2.7	Supply voltage stability	±5% variation, reference to frequency at 3.3V, typical	±10	ppb
2.8	Load sensitivity	±5pF variation, reference to frequency at 15pF, typical	±10	ppb
2.9	Warm-up time	Note 2, typically less than	3	minutes
2.10	g-sensitivity	Gamma vector of all three axes from 30 Hz to 1500 Hz, typically less than	2	ppb/g
2.11	Holdover drift	24 hours, temperature variation $\leq \pm 1$ °C (note 3), typically less than	±4	ppb
2.12	Free-run accuracy	All causes, 20 years life, reference to nominal frequency	±4.6 max	ppm
3.0	FREQUENCY AGING			
Line	Parameter	Test Condition	Value	Unit
3.1	Long term stability	Per day (note 3), typically less than	±2	ppb
3.2	Long term stability	First year	±1 max	ppm
3.3	Long term stability	20 years	±3 max	ppm
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4.0	ROOT ALLAN VARIANCE			
Line	Parameter	Test Condition	Value	Unit
4.1	Root Allan Variance	Typical value at 25°C, tau = 0.1s	7	E-11
4.2	Root Allan Variance	Typical value at 25°C, tau = 1.0s	7	E-11
4.3	Root Allan Variance	Typical value at 25°C, tau = 10s	7	E-11
4.4	Root Allan Variance	Typical value at 25°C, tau = 100s	8	E-11
4.5	Root Allan Variance	Typical value at 25°C, tau = 1000s	8	E-11
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5.0	POWER SUPPLY			
Line	Parameter	Test Condition	Value	Unit
5.1	Supply voltage	±5%	3.3	V
5.2	Input power	Warm up, typical	600	mW
5.3	Input power	Steady state in still air at 25°C	400 max	mW

6.0	HCMOS OSCILLATOR OUTPUT				
Line	Parameter	Test Condition	Value	Unit	
6.1	Output waveform	HCMOS			
6.2	Output voltage level low	Measured with a capacitive load of 15pF	10 max	%Vcc	
6.3	Output voltage level high	Measured with a capacitive load of 15pF	90 min	%Vcc	
6.4	Rise and fall times	Measured with a capacitive load of 15pF	4 max	ns	
6.5	Duty cycle	Measured at 50% level	45 to 55	%	
6.6	Output load	Nominal	15	pF	
7.0	SSB PHASE NOISE				
Line	Parameter	Test Condition	Value	Unit	
7.1	SSB phase noise power density at 1 Hz offset	Typical value	-64	dBc/Hz	
7.2	SSB phase noise power density at 10 Hz offset	Typical value	-92	dBc/Hz	
7.3	SSB phase noise power density at 100 Hz offset	Typical value	-117	dBc/Hz	
7.4	SSB phase noise power density at 1kHz offset	Typical value	-137	dBc/Hz	
7.5	SSB phase noise power density at 10kHz offset	Typical value	-148	dBc/Hz	
7.6	SSB phase noise power density at 100kHz offset	Typical value	-151	dBc/Hz	
7.7	SSB phase noise power density at 1MHz offset	Typical value	-152	dBc/Hz	
8.0	ENVIRONMENTAL				
Line	Parameter	Test Condition	Value	Unit	
8.1	Storage temperature		-55 to 125	°C	
8.2	Acceleration steady state	IEC 60068-2-7 test Ga, 5000g, 10s (at peak acceleration), Y-axis only			
8.3	Moisture sensitivity	IPC/JEDEC J-STD-020, Class 1			
8.4	Temperature cycling	IEC 60068-2-14 test Na, 400 cycles, -40°C to +125°C			
8.5	Solderability	JESD 22-B102D, Method 2 Preconditioning 150°C, 16 hours			
8.6	Humidity	EIA/JEDEC22-A101, 85°C/85%R.H., 1000 hours			
8.7	Shock	IEC 60068-2-27, test Ea; 1500g, 0.5ms, 18 shocks total			
8.8	Vibration	IEC 60068-2-6, test Fc: 20g, 60 to 2000Hz 12 hours total			
8.9	RoHS	Parts are fully compliant with the European Union directive 2002/95/EC on the restriction of the use of certain hazardous substances in electrical and electronic equipment. Note parts are suitable for assembly using both Lead-free solders and Tin/Lead solders			
9.0	PIN CONNECTIONS				
Line	Parameter	Description			
9.1	Pin 1: Do Not Connect				
9.2	Pin 2: GND				
9.3	Pin 3: OUTPUT				
9.4	Pin 4: VCC	For correct operation decouple the supply voltage with a 10 $\mu F$ capa	icitor close to th	ne oscillator	

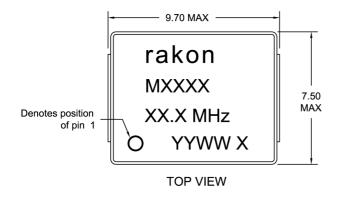
10.0	MARKING		
Line	Parameter	Description	
10.1	Туре	Laser marked	
10.2	Line 1	RAKON	
10.3	Line 2	Part number (Mxxxx)	
10.4	Line 3	Frequency in MHz (xx.x MHz)	
10.5	Line 4	Pin 1 identifier (indent), and date / location code (YYWWX)	
11.0	MANUFACTURING INFORMATION		
Line	Parameter	Description	
11.1	Reflow	IPC/JEDEC J-STD-020, Package reflow temperature for the Pb-Free process is 250°C, or for the Sn-Pb eutectic process is 220°C. The solder reflow processes are as per the attached profiles	
11.2	Packaging description	Tape and reel. $\%$ mm wide tape and Ø330mm (Ø13") reel. Standard packing quantity is 100 to 1000 units per reel	
12.0	SPECIFICATION NOTES		
Line	Parameter	Description	
12.1	Note 1	The characteristics of the component may be temporarily affected by the processes of assembly and soldering. The frequency specifications apply 48 hours after assembly. Nominal conditions apply unless otherwise stated.	
12.2	Note 2	Time needed for frequency to be within $\pm 20$ ppb reference to frequency after 1 hour, at 25°C. Parameter is frequency, assembly and operating history dependent.	

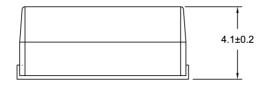
After 30 days of continuous operation.

12.3 Note 3

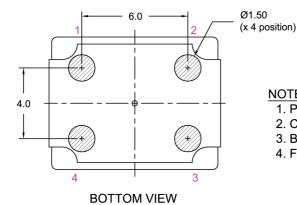
## Drawing Name: RFPO40/45 Model Drawing

#### MODEL DRAWING





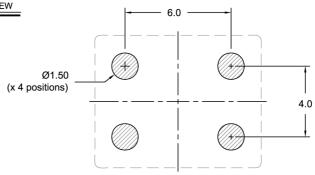
#### **FRONT VIEW**



### NOTE:

- 1. Pin connections are detailed in the specification.
- 2. Cover: Plastic
- 3. Base: FR4
- 4. Finish:  $0.05 \sim 0.13 \mu mGold over 3 \sim 6 \mu m Nickel$ .

## RECOMMENDED PAD LAYOUT - TOP VIEW



TITLE: RFPO40/45 MODEL DRAWING

**RELATED DRAWINGS:** 

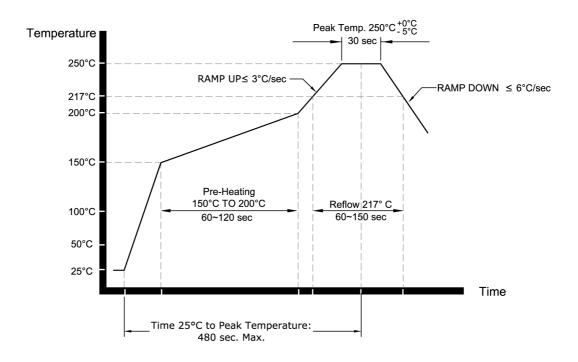
FILENAME: CAT646 REVISION: DATE: 25-Jan-12 SCALE: Millimetres

TOLERANCES: X.XX = X.XXX = X° = Hole

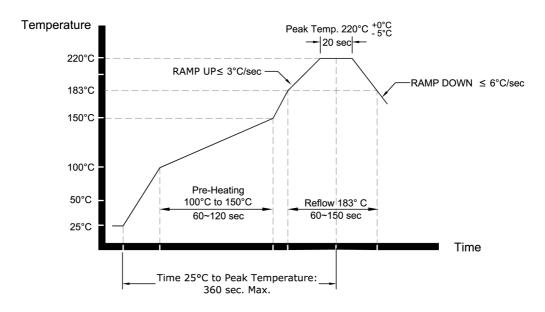


## Drawing Name: RFPO40 Series Reflow

#### Pb-Free Reflow Soldering Profile \*



## Sn-Pb Eutectic Reflow Soldering Profile \*



#### \* NOTE:

These profile were used during the qualification testing of the product and therefore represents worst case conditions. It is not recommended for use by the customer in the actual assembly of these parts.

TITLE: RFPO40 SERIES REFLOW FILENAME: CAT649

RELATED DRAWINGS: REVISION: A

DATE: 25-Oct-11
SCALE: NTS
Millimetres

